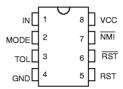


# DS1231/S Power Monitor Chip

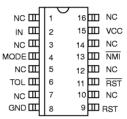
#### **FEATURES**

- Warns processor of an impending power failure
- Provides time for an orderly shutdown
- Prevents processor from destroying nonvolatile memory during power transients
- Automatically restarts processor after power is restored
- Suitable for linear or switching power supplies
- Adjusts to hold time of the power supply
- Supplies necessary signals for processor interface
- Accurate 5% or 10% V<sub>CC</sub> monitoring
- Replaces power-up reset circuitry
- No external capacitors required
- Optional 16-pin SOIC surface mount package

#### **PIN ASSIGNMENT**



DS1231 8-Pin DIP (300 MIL) See Mech. Drawings Section



DS1231S 16-Pin SOIC (300 MIL) See Mech. Drawings Section

### PIN DESCRIPTION

IN - Input

MODE – Selects input pin characteristics TOL – Selects 5% or 10% V<sub>CC</sub> detect

GND - Ground

RST - Reset (Active High)

RST - Reset (Active Low, open drain)

NMI - Non-Maskable Interrupt

V<sub>CC</sub> – +5V Supply NC – No Connections

#### DESCRIPTION

The DS1231 Power Monitor Chip uses a precise temperature-compensated reference circuit which provides an orderly shutdown and an automatic restart of a processor-based system. A signal warning of an impending power failure is generated well before regulated DC voltages go out of specification by monitoring high voltage inputs to the power supply regulators. If line isolation is required a UL-approved opto-isolator can be directly interfaced to the DS1231. The time for processor

shutdown is directly proportional to the available hold-up time of the power supply. Just before the hold-up time is exhausted, the Power Monitor unconditionally halts the processor to prevent spurious cycles by enabling Reset as  $V_{\rm CC}$  falls below a selectable 5 or 10 percent threshold. When power returns, the processor is held inactive until well after power conditions have stabilized, safeguarding any nonvolatile memory in the system from inadvertent data changes.

#### **OPERATION**

The DS1231 Power Monitor detects out-of-tolerance power supply conditions and warns a processor-based system of impending power failure. The main elements of the DS1231 are illustrated in Figure 1. As shown, the DS1231 actually has two comparators, one for monitoring the input (Pin 1) and one for monitoring  $V_{CC}$  (Pin 8). The  $V_{CC}$  comparator outputs the signals RST (Pin 5) and  $\overline{RST}$  (Pin 6) when  $V_{CC}$  falls below a preset trip level as defined by TOL (Pin 3).

When TOL is connected to ground, the RST and  $\overline{RST}$  signals will become active as  $V_{CC}$  goes below 4.75 volts. When TOL is connected to  $V_{CC}$ , the RST and  $\overline{RST}$  signals become active as  $V_{CC}$  goes below 4.5 volts. The RST and  $\overline{RST}$  signals are excellent control signals for a microprocessor, as processing is stopped at the last possible moments of valid  $V_{CC}$ . On power-up, RST and  $\overline{RST}$  are kept active for a minimum of 150 ms to allow the power supply to stabilize (see Figure 2).

The comparator monitoring the input pin produces the NMI signal (Pin 7) when the input threshold voltage (V<sub>TP</sub>) falls to a level as determined by Mode (Pin 2). When the Mode pin is connected to V<sub>CC</sub>, detection occurs at V<sub>TP</sub>-. In this mode Pin 1 is an extremely high impedance input allowing for a simple resistor voltage divider network to interface with high voltage signals. When the Mode pin is connected to ground, detection occurs at  $V_{TP}$ +. In this mode Pin 1 sources 30  $\mu A$  of current allowing for connection to switched inputs, such as a UL-approved opto-isolator. The flexibility of the input pin allows for detection of power loss at the earliest point in a power supply system, maximizing the amount of time allotted between NMI and RST. On power-up, NMI is released as soon as the input threshold voltage  $(V_{TP})$ is achieved and V<sub>CC</sub> is within nominal limits. In both modes of operation the input pin has hysteresis for noise immunity (Figure 3).

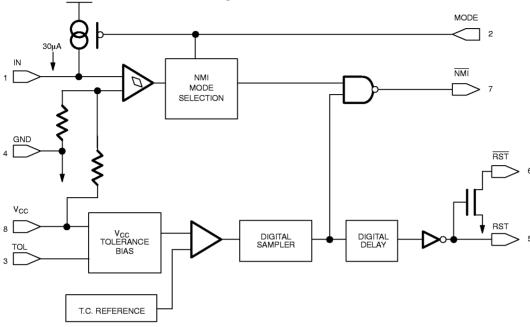
# APPLICATION – MODE PIN CONNECTED TO V<sub>CC</sub>

When the Mode pin is connected to V<sub>CC</sub>, pin 1 is a high impedance input. The voltage sense point and the level of voltage at the sense point are dependent upon the application (Figure 4). The sense point may be developed from the AC power line by rectifying and filtering the AC. Alternatively, a DC voltage level may be selected which is closer to the AC power input than the regulated +5-volt supply, so that ample time is provided for warning before regulation is lost.

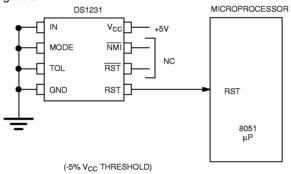
Proper operation of the DS1231 requires a maximum voltage of 5 volts at the input (Pin 1), which must be derived from the maximum voltage at the sense point. This is accomplished with a simple voltage divider network of R1 and R2. Since the IN trip point  $V_{TP}$ - is 2.3 volts (using the -20 device), and the maximum allowable voltage on pin 1 is 5 volts, the dynamic range of voltage at the sense point is set by the ratio of 2.3/5.0=.46 min. This ratio determines the maximum deviation between the maximum voltage at the sense point and the actual voltage which will generate  $\overline{\text{NMI}}$ .

Having established the desired ratio, and confirming that the ratio is greater than .46 and less than 1, the proper values for R1 and R2 can be determined by the equation as shown in Figure 4. A simple approach to solving this equation is to select a value for R2 which is high enough impedance to keep power consumption low, and solve for R1. Figure 5 illustrates how the DS1231 can be interfaced to the AC power line when the mode pin is connected to  $V_{\rm CC}$ .

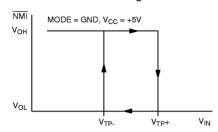
# **POWER MONITOR BLOCK DIAGRAM** Figure 1



# POWER-UP RESET Figure 2

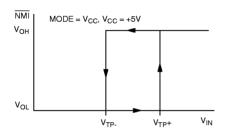


## **INPUT PIN HYSTERESIS** Figure 3

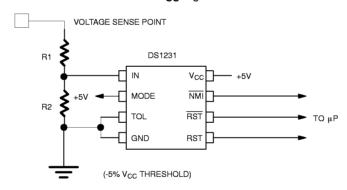


	-20	-35	-50
V <sub>TP-</sub>	2.3	2.15	2.0
V <sub>TP</sub> +	2.5	2.5	2.5

NOTE: HYSTERESIS TOLERANCE IS ±60 mV



# APPLICATION WITH MODE PIN CONNECTED TO $V_{CC}$ Figure 4



V SENSE = 
$$\frac{R1 + R2}{R2}$$
 X 2.3 V MAX =  $\frac{V \text{ SENSE}}{VTP}$  X 5.0

EXAMPLE: V SENSE = 8 VOLTS AT TRIP POINT AND A MAXIMUM VOLTAGE OF 17.5V WITH R2 = 10K

THEN 8 = 
$$\frac{R1 + 10K}{10K}$$
 X 2.3 R1 = 25K

NOTE: RST requires a pull-up resister.

# APPLICATION – MODE PIN CONNECTED TO GROUND

When the Mode pin is connected to ground, pin 1 is a current source of 30  $\mu$ A with a V<sub>TP+</sub> of 2.5 volts. Pin 1 is held below the trip point by a switching device like an opto-isolator as shown in Figure 6. Determination of the sense point has the same criteria as discussed in the previous application. However, determining component values is significantly different. In this mode, the maximum dynamic range of the sense point versus desired trip voltage is primarily determined by the selection of a zener diode. As an example, if the maximum voltage at the sense point is 200V and the desired trip point is 150V, then a zener diode of 150V will approximately set

the trip point. This is particularly true if power consumption on the high voltage side of the opto-isolator is not an issue. However, if power consumption is a concern, then it is desirable to make the value of R1 high. As the value of R1 increases, the effect of the LED current in the opto-isolator starts to affect the IN trip point. This can be seen from the equation shown in Figure 6. R1 must also be low enough to allow the opto-isolator to sink the 30  $\mu\text{A}$  of collector current required by pin 1 and still have enough resistance to keep the maximum current through the opto-isolator's LED within data sheet limits. Figure 7 illustrates how the DS1231 can be interfaced to the AC power line when the mode pin is grounded.

#### **AC VOLTAGE MONITOR WITH TRANSFORMER ISOLATION** Figure 5

DS1231 -10% V<sub>CC</sub> THRESHOLD

IN V<sub>CC</sub> +5V<sub>DC</sub>

MODE NMI

+5V<sub>DC</sub>

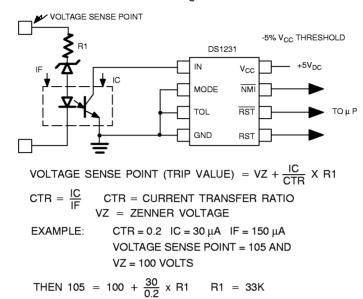
TOL RST

TO µ

VOLTAGE SENSE POINT

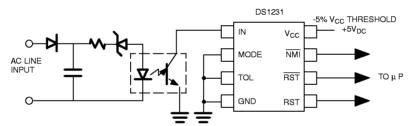
NOTE: RST requires a pull-up resister.

#### **APPLICATION WITH MODE PIN GROUNDED Figure 6**



NOTE: RST requires a pull-up resister.

## AC VOLTAGE MONITOR WITH OPTO-ISOLATION Figure 7



NOTE: RST requires a pull-up resister.

#### **ABSOLUTE MAXIMUM RATINGS\***

Voltage on V<sub>CC</sub> Pin Relative to Ground Voltage on I/O Relative to Ground Operating Temperature (Industrial Version) Storage Temperature Soldering Temperature

-0.5V to +7.0V -0.5V to V<sub>CC</sub> + 0.5V 0°C to 70°C -40°C to +85°C -55°C to +125°C 260°C for 10 seconds

#### RECOMMENDED DC OPERATING CONDITIONS

(0°C to 70°C)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Supply Voltage	V <sub>CC</sub>	4.5	5.0	5.5	V	1
Input Pin 1	V <sub>IN</sub>			V <sub>CC</sub>	V	1

#### DC ELECTRICAL CHARACTERISTICS

(0°C to 70°C;  $V_{CC} = 4.5$  to 5.5V)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Low Level @ RST	V <sub>OL</sub>			0.4	٧	1
Output Voltage @ –500 μA	V <sub>OH</sub>	V <sub>CC</sub> -0.5V	V <sub>CC</sub> -0.1V		٧	1, 6
Input Leakage	I <sub>IL</sub>	-10		+10	μΑ	2
Output Current @2.4V	l <sub>OH</sub>	1.0	2.0		mA	5
Output Current @0.4V	l <sub>OL</sub>	2.0	3.0		mA	
Operating Current	Icc		0.5	2.0	mA	3
Input Pin 1 (Mode=GND)	Ic	15	25	50	μΑ	
Input Pin 1 (Mode=V <sub>CC</sub> )	Ic			0.1	μА	
IN Trip Piont (Mode=GND)	V <sub>TP</sub>	See Figure 3				1
IN Trip Point (Mode=V <sub>CC</sub> )	V <sub>TP</sub>		1			
V <sub>CC</sub> Trip Point (TOL=GND)	V <sub>CCTP</sub>	4.50	4.62	4.74	٧	1
V <sub>CC</sub> Trip Point (TOL=V <sub>CC</sub> )	V <sub>CCTP</sub>	4.25	4.37	4.49	٧	1

# CAPACITANCE

 $(T_A = 25^{\circ}C)$ 

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Input Capacitance	C <sub>IN</sub>			5	pF	
Output Capacitance	C <sub>OUT</sub>			7	pF	

<sup>\*</sup> This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

#### **AC ELECTRICAL CHARACTERISTICS**

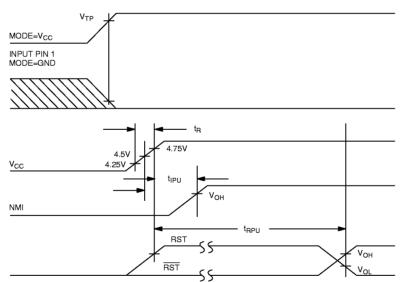
 $(0^{\circ}\text{C to } 70^{\circ}\text{C}; V_{CC} = 5\text{V} \pm 10\%)$ 

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
V <sub>TP</sub> to NMI Delay	t <sub>IPD</sub>			1.1	μs	
V <sub>CC</sub> Slew Rate 4.75-4.25V	t <sub>F</sub>	300			μs	
V <sub>CC</sub> Detect to RST and RST	t <sub>RPD</sub>			100	ns	
V <sub>CC</sub> Detect to NMI	t <sub>IPU</sub>			200	μs	4
V <sub>CC</sub> Detect to RST and RST	t <sub>RPU</sub>	150	500	1000	ms	4
V <sub>CC</sub> Slew Rate 4.25-4.75V	t <sub>R</sub>	0			ns	

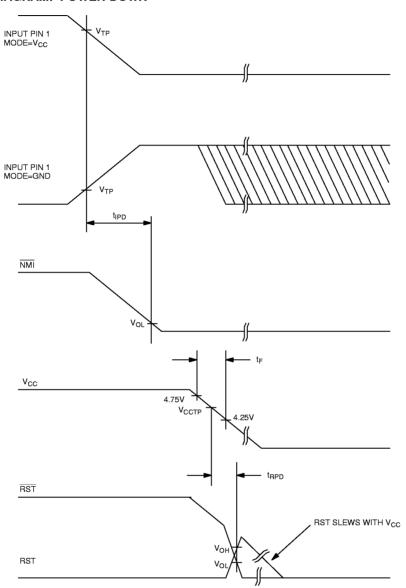
## NOTES:

- 1. All voltages referenced to ground.
- 2.  $V_{CC} = +5.0$  volts with outputs open.
- 3. Measured with outputs open.
- 4.  $t_R = 5 \mu s$ .
- 5.  $\overline{\text{RST}}$  is an open drain output and requires a pull-up resister.
- 6. RST remains within 0.5V of  $V_{CC}$  on power–down until  $V_{CC}$  drops below 2.0V.  $\overline{RST}$  remains within 0.5V of GND on power–down until  $V_{CC}$  drops below 2.0V.

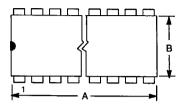
## TIMING DIAGRAM: POWER-UP

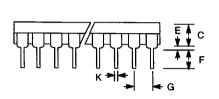


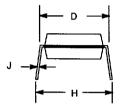
# TIMING DIAGRAM: POWER-DOWN



# 8- TO 28-PIN DIP (300 MIL)







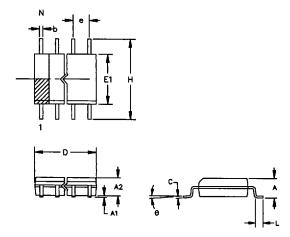
Includes:		
DS1000	DS1211	DS1621
DS1000M	DS1215	DS1625
DS1003	DS1221	DS1632
DS1003M	DS1222	DS1640
DS1004M	DS1228	DS1651
DS1005	DS1229	DS1652
DS1005M	DS1231	DS1652B
DS1007	DS1232	DS1653
DS1010	DS1232LP	DS1666
DS1012M	DS1234	DS1667
DS1013	DS1236	DS1669
DS1013M	DS1237	DS1802
DS1020	DS1238	DS1830
DS1033M	DS1239	DS1832
DS1035M	DS1259	DS1867
DS1040M	DS1267	DS1868
DS1044	DS1275	DS1869
DS1045	DS1291	DS2009D
DS1200	DS1293	DS2010D
DS1206	DS1336	DS2011D
DS1210	DS1620	DS2013D

PKG	8-F	PIN	10-	PIN	14-	PIN	16-PIN	
DIM	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX
A IN.	0.360	0.400	0.480	0.520	0.740	0.780	0.740	0.780
MM	9.14	10.16	12.19	13.21	18.80	19.81	18.80	19.81
B IN.	0.240	0.260	0.240	0.260	0.240	0.260	0.240	0.260
MM	6.10	6.60	6.10	6.60	6.10	6.60	6.10	6.60
C IN.	0.120	0.140	0.120	0.140	0.120	0.140	0.120	0.140
MM	3.05	3.56	3.05	3.56	3.05	3.56	3.05	3.56
D IN.	0.300	0.325	0.300	0.325	0.300	0.325	0.300	0.325
MM	7.62	8.26	7.62	8.26	7.62	8.26	7.62	8.26
E IN.	0.015	0.040	0.015	0.040	0.015	0.040	0.015	0.040
MM	0.38	1.02	0.38	1.02	0.38	1.02	0.38	1.02
F IN.	0.120	0.140	0.110	0.130	0.120	0.140	0.120	0.140
MM	3.04	3.56	2.79	3.30	3.04	3.56	3.04	3.56
G IN.	0.090	0.110	0.090	0.110	0.090	0.110	0.090	0.110
MM	2.29	2.79	2.29	2.79	2.29	2.79	2.29	2.79
H IN	0.320	0.370	0.320	0.370	0.320	0.370	0.320	0.370
MM	8.13	9.40	8.13	9.40	8.13	9.40	8.13	9.40
J IN	0.008	0.012	0.008	0.012	0.008	0.012	0.008	0.012
MM	0.20	0.30	0.20	0.30	0.20	0.30	0.20	0.30
K IN.	0.015	0.021	0.015	0.021	0.015	0.021	0.015	0.021
MM	0.38	0.53	0.38	0.53	0.38	0.53	0.38	0.53

Continued on following page.

# MECHANICAL DRAWINGS

# 16-, 20-, 24-, 28-PIN SOIC (300 MIL)



Includes:		
DS1000S	DS1227S	DS1360S
DS1005\$	DS1231S	DS1380\$
DS1007S	DS1228S	DS1609S
DS1010S	DS1229S	DS1610S
DS1013S	DS1232S	DS1620
DS1020S	DS1232LPS	DS1632S
DS1021S	DS1234S	DS1640S
DS1045S	DS1236S	DS1653S
DS1200S	DS1237S	DS1710S
DS1205S	DS1238S	DS2107AS
DS1206	DS1239S	DS2107S
DS1209S-B1	DS1259S	DS2175S
DS1210S	DS1267S	DS2186S
DS1211S	DS12885S	DS2187S
DS1215S	DS1336S	DS2188S
DS1221S	DS1359S	
DS1222S		

The chamfer on the body is optional. If it is not present, a terminal 1 identifier must be positioned so that 1/2 or more of its area is contained in the hatched zone.

PKG	16-PIN		20-	PIN	24-	PIN	28-	PIN
DIM	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX
A IN.	0.094	0.105	0.094	0.105	0.094	0.105	0.094	0.105
MM	2.38	2.68	2.38	2.68	2.38	2.68	2.39	2.67
A1 IN.	0.004	0.012	0.004	0.012	0.004	0.012	0.004	0.012
MM	0.102	0.30	0.102	0.30	0.102	0.30	0.102	0.30
A2 IN.	0.089	0.095	0.089	0.095	0.089	0.095	0.089	0.095
MM	2.26	2.41	2.26	2.41	2.26	2.41	2.26	2.41
b IN.	0.013	0.020	0.013	0.020	0.013	0.020	0.013	0.020
MM	0.33	0.51	0.33	0.51	0.33	0.51	0.33	0.51
C IN	0.009	0.013	0.009	0.013	0.009	0.013	0.009	0.013
MM	0.229	0.33	0.229	0.33	0.229	0.33	0.229	0.33
D IN.	0.398	0.412	0.498	0.511	0.598	0.612	0.698	0.712
MM	10.11	10.46	12.65	12.99	15.19	15.54	17.73	18.08
e IN. MM				BSC BSC				BSC BSC
E1 IN.	0.290	0.300	0.290	0.300	0.290	0.300	0.290	0.300
MM	7.37	7.62	7.37	7.62	7.37	7.62	7.37	7.62
H IN	0.398	0.416	0.398	0.416	0.398	0.416	0.398	0.416
MM	10.11	10.57	10.11	10.57	10.11	10.57	10.11	10.57
L IN	0.016	0.040	0.016	0.040	0.016	0.040	0.016	0.040
	0.40	1.02	0.406	1.20	0.40	1.02	0.40	1.02
Θ	0°	8°	0°	8°	0°	8°	0°	8°

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